

## Dual-Cure 9483 High Performance (Automotive) Light/Moisture Cure Conformal Coating

**APPLICATIONS**

- Conformal Coatings
- Automotive Sensors
- Control Modules
- Automotive Miscellaneous

**FEATURES**

- UV/Visible Light Cure
- Secondary Moisture Cure
- Excellent Thermal Shock Resistance
- Corrosion Resistant
- Temperature/Humidity Performance
- Bright Blue Fluorescing

**RECOMMENDED SURFACES**

- Rigid Printed Circuit Boards (PWBs)
- Flexible Printed Circuits (FPCs)

Dymax Dual-Cure 9483 is a high performance light and moisture-cure re-workable conformal coating especially formulated to ensure complete cure for coating that flows underneath on printed circuit boards. Coating in shadow areas cures over time with ambient moisture. Dymax 9483 is engineered for coating thicknesses up to 0.203 mm (0.008 in). This conformal coating fluoresces a vivid blue when exposed to UV light (365 nm) for easy inspection of coating coverage. Dymax Dual-Cure materials contain no nonreactive solvents. Their ability to cure in seconds enables faster processing, greater output, and lower processing costs. When cured with Dymax light-curing, focused-beam lamps, or flood lamps, they deliver optimum speed and performance for electronic assembly. Dymax lamps offer the ideal balance of UV and visible light for the fastest, deepest cures. This product is in full compliance with RoHS directives 2015/863/EU.

**UNCURED PROPERTIES \***

Property	Value	Test Method
Solvent Content	No Nonreactive Solvents	N/A
Chemical Class	Acrylated Urethane	N/A
Appearance	Clear, Light Yellow Liquid	N/A
Soluble in	Organic Solvents	N/A
Density, g/ml	1.09	ASTM D1875
Viscosity, cP (20 rpm)	690 (nominal)	DSTM 502

**CURED MECHANICAL PROPERTIES \***

Property	Value	Test Method
Durometer Hardness $\Omega$	A55	ASTM D2240
Durometer Hardness $\text{¥}$	D60	ASTM D2240
Tensile at Break, MPa [psi] $\text{¥}$	16.2 [2,350]	ASTM D638
Elongation at Break, % $\text{¥}$	22	ASTM D638
Modulus of Elasticity, Mpa [psi] $\text{¥}$	276 [40,000]	ASTM D638

**OTHER CURED PROPERTIES \*  $\text{¥}$** 

Property	Value	Test Method
Refractive Index (20°C)	1.51	ASTM D542
Boiling Water Absorption, % (2 h)	1.4	ASTM D570
Water Absorption, % (25°C, 24 h)	0.3	ASTM D570
Linear Shrinkage, %	2.0	ASTM D2566
Glass Transition $T_g$ , °C	57	DSTM 256 $\ddagger$
CTE $\alpha_1$ , $\mu\text{m/m}^\circ\text{C}$	87	DSTM 610 $\ddagger$
CTE $\alpha_2$ , $\mu\text{m/m}^\circ\text{C}$	188	DSTM 610 $\ddagger$

\* Not Specifications

$\text{¥}$  Measured after UV cure followed by 15 days at 25°C / 50% RH

$\Omega$  Measured after UV cure only

N/A Not Applicable

$\ddagger$  DSTM Refers to Dymax Standard Test Method

**ELECTRICAL PROPERTIES \*  $\text{¥}$** 

Property	Value	Test Method
Dielectric Constant (1 MHz)	3.26	ASTM D150
Dissipation Factor (1 MHz)	0.2	ASTM D150
Dielectric Withstand Voltage, kV/mm [V/mil]	59 [1500]	ASTM D149
Volume Resistivity, ohm-cm	4.39E+14	ASTM D257
Surface Resistivity, ohm	2.22E+12	ASTM D257

**ADHESION  $\Omega$** 

Substrate	Recommendation
Lead Frame	✓
Ceramic	✓
PCB	✓
Flex	✓

✓ Recommended Adhesive

o Limited Applications

st Requires Surface Treatment (e.g. plasma, corona treatment, etc.)



**CURING GUIDELINES**

UV and moisture curing guideline for 9483 up to 0.2mm [0.008 in]

Dymax Curing System (Intensity)	Exposure Time or Belt Speed	Moisture Curing (after light cure)	Only Moisture Cure for (Shadow Areas)
UVCS Conveyor with Fusion F300S (2.5 W/cm <sup>2</sup> ) <sup>B</sup>	1.5 m/min 5 ft/min	7 days at 25°C / 50% RH or 2 days at 40°C / 50%	2-3 days at 25°C / 50% RH
5000-EC (200 mW/cm <sup>2</sup> ) <sup>A</sup>	50s		
UVCS Conveyor with 5000-EC (200 mW/cm <sup>2</sup> ) <sup>B</sup>	0.3 m/min 1 ft/min		

A. Intensity was measured over the UVA range (320-395 nm) using a Dymax ACCU-CAL™ 50 Radiometer.

B. At 53 mm [2.1 in] focal distance. Maximum speed of conveyor is 8.2 m/min [27 ft/min]. Intensity was measured over the UVA range (320-395 nm) using the Dymax ACCU-CAL™ 150 Radiometer.

**SECONDARY MOISTURE CURE**

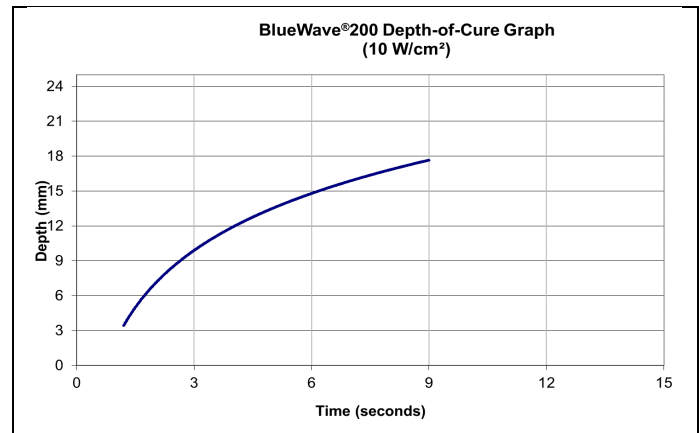
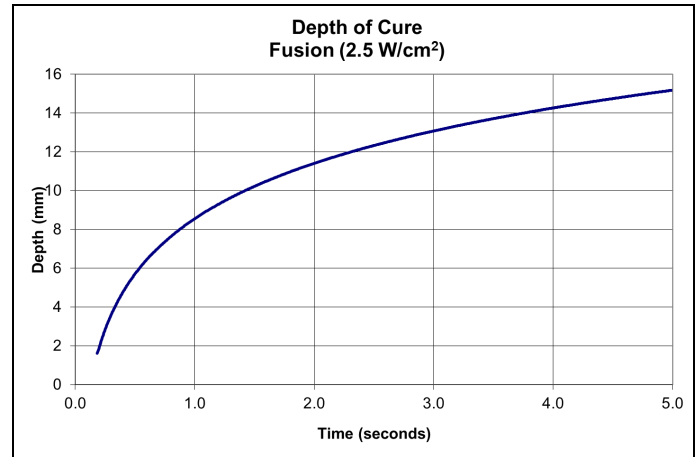
A combination of light and moisture cure is required to achieve full cured mechanical properties. Moisture is also used as a secondary cure mechanism for shadow areas that cannot be cured with light. While moisture cure time in shadow areas is typically 2-3 days at 25°C [77°F], 50% RH, actual moisture cure time is application specific and may vary. For adhesive that has been light cured, typical full property development is after 7 days at 25°C [77°F], 50% RH. Cure time for both light cured and shadow areas depends on humidity level, amount of coating in shadow areas, and proximity of shadow coating to humidity. Coating entrapped under large components may have a prolonged cure time. Exposure to heat (typically 65°C-80°C) and higher relative humidity will accelerate cure. Accelerated moisture cure time is also dependent on the variables listed above.

Full cure is best determined empirically by curing at different times and intensities, and measuring the corresponding change in cured properties such as tackiness, adhesion, hardness, etc. Full cure is defined as the point at which more light and/or ambient exposure no longer improves cured properties.

Dymax recommends that customers employ a safety factor by curing longer and/or at higher intensities than required for full cure. Although Dymax Application Engineering can provide technical support and assist with process development, each customer must ultimately determine and qualify the appropriate curing parameters required for their unique application.

**DEPTH OF CURE**

The graph below shows the increase in depth of cure as a function of exposure time. A 9.5 mm [0.37 in] diameter specimen was cured in a polypropylene mold and cooled to room temperature. It was then released from the mold and the cure depth was measured.



**OPTIMIZING PERFORMANCE AND HANDLING**

1. This product cures with exposure to UV and visible light as well as moisture. Exposure to ambient and artificial light and moisture should be kept to a minimum before curing. Dispensing components including needles and fluid lines should be 100% light blocking, not just UV blocking.
2. All bond surfaces should be clean and free from grease, mold release, or other contaminants prior to dispensing the adhesive.
3. Cure speed is dependent upon many variables, including lamp intensity, distance from the light source, required depth of cure, bond gap, and percent light transmission of the substrate.
4. Oxygen in the atmosphere may inhibit surface cure. Surfaces exposed to air may require high-intensity UV light to produce a dry surface cure. Flooding the bond area with an inert gas, such as nitrogen, can also reduce the effects of oxygen inhibition.
5. Parts should be allowed to cool after cure before testing and subjecting to any loads.
6. In rare cases, stress cracking may occur in assembled parts. Three options may be explored to eliminate this problem. One option is to heat anneal the parts to remove molded-in stresses. A second option is to open the gap between mating parts to reduce stress caused by an interference fit. The third option is to minimize the amount of time the liquid adhesive remains in contact with the substrate(s) prior to curing.
7. Light curing generally produces some heat. If necessary, cooling fans can be placed in the curing area to reduce the heating effect on components.
8. At the point of curing, an air exhaust system is recommended to dissipate any heat and vapors formed during the curing process.
9. Resealing opened container under a dry, inert gas, such as nitrogen, can help to prolong the shelf life.
10. Light cure is recommended prior to moisture cure. Full cure develops after both light and moisture cure, not one or the other.

**DISPENSING THE RESIN**

This material may be dispensed with a variety of manual, semi-automated and fully automated fluid delivery systems. Dymax has several dispensing systems that may be suitable for use with this material such as our model 110 mountable atomizing needle valve or SG-100-RS handheld spray gun. Small area applications including beads and small dots can be achieved using hand-held dispensers such as our SD-100 syringe dispenser and our Model 400 needle valve systems. These valve systems can be used in a manual, semi-automated or fully automated application. Actual dispensing options, vary by material properties. Questions relating to and defining the best fluid delivery system and curing equipment for specific applications should be discussed with the Dymax Application Engineering Team.

**STORAGE AND SHELF LIFE**

Store the material in a cool, dark place when not in use. Do not expose to light. This product may polymerize upon prolonged exposure to ambient and artificial light as well as atmospheric moisture. Keep covered when not in use. This material has a 7-month shelf life from date of manufacture, unless otherwise specified, when stored between 10°C (50°F) and 35°C (90°F) in the original, unopened container.

**CLEANUP**

Uncured material may be removed from dispensing components and parts with organic solvents. Cured material will be impervious to many solvents and difficult to remove. Cleanup of cured material may require mechanical methods such as ultrasonic bath, water jet, vacuum tweezers, air knife and/ or warming to aid in the removal.

**GENERAL INFORMATION**

This product is intended for industrial use only. Keep out of the reach of children. Avoid breathing vapors. Avoid contact with skin, eyes, and clothing. Wear impervious gloves. Repeated or continuous skin contact with uncured material may cause irritation. Remove material from skin with soap and water. Never use organic solvents to remove material from skin and eyes. For more information on the safe handling of this material, please refer to the Safety Data Sheet before use.

The data provided in this document are based on historical testing that Dymax performed under laboratory conditions as they existed at that time, and are for informational purposes only. The data are neither specifications nor guarantees of future performance in a particular application. Dymax does not guarantee that this product's properties are suitable for the user's intended purpose.

Numerous factors—including, without limitation, transport, storage, processing, the material with which the product is used, and the ultimate function or purpose for which the product was obtained—may affect the product's performance and/or may cause the product's actual behavior to deviate from its behavior in the laboratory. None of these factors are within Dymax's control. Conclusions about the behavior of the product under the user's particular conditions, and the product's suitability for a specific purpose, cannot be drawn from the information contained in this document.

It is the user's responsibility to determine (i) whether a product is suitable for the user's particular purpose or application and (ii) whether it is compatible with the user's intended manufacturing process, equipment, and methods. Under no circumstances will Dymax be liable for determining such suitability or compatibility. Before the user sells any item that incorporates Dymax's product, the user shall adequately and repetitively test the item in accordance with the user's procedures and protocols. Unless specifically agreed to in writing, Dymax will have no involvement in, and shall under no circumstances be liable for, such testing.

Dymax makes no warranties, whether express or implied, concerning the merchantability of this product or its fitness for a particular purpose. Nothing in this document should be interpreted as a warranty of any kind. Under no circumstances will Dymax be liable for any injury, loss, expense or incidental or consequential damage of any kind allegedly arising in connection with the user's handling, processing, or use of the product. It is the user's responsibility to adopt appropriate precautions and safeguards to protect persons and property from any risk arising from such handling, processing, or use.

The specific conditions of sale for this product are set forth in Dymax's Conditions of Sale which are available at <https://www.dymax.com/index.php/en/resources/sales-terms-conditions>. Nothing contained herein shall act as a representation that the product use or application is free from patents owned by Dymax or any others. Nothing contained herein shall act as a grant of license under any Dymax Corporation Patent.

Except as otherwise noted, all trademarks used herein are trademarks of Dymax. The "®" symbol denotes a trademark that is registered in the U.S. Patent and Trademark Office.

The contents of this document are subject to change. Unless specifically agreed to in writing, Dymax shall have no obligation to notify the user about any change to its content.